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(54) Title: INTEGRATED PLATFORM AND FUEL CELL COOLING

(57) Abstract: A fuel cell and a platform associated with the fuel cell include a common fluid cooling system.

INTEGRATED PLATFORM AND FUEL CELL COOLING

Field

The present invention relates generally to cooling electronic systems, and more
5 specifically to cooling of fuel cells.

Background

Fuel cells typically generate heat as a by-product of operation. As fuel cell designs
mature and fuel cells become smaller, it becomes more difficult to remove the generated
10 heat.

Brief Description of the Drawings

Figure 1 shows a diagram of an electronic system with a cooling system;
Figure 2 shows a diagram of example heat generating devices;
15 Figure 3 shows an exploded view of a fuel cell;
Figure 4 shows a diagram of a control system;
Figure 5 shows an electronic system having a processor and memory;
Figure 6 shows a flowchart in accordance with various embodiments of the present
invention; and
20 Figures 7-9 show system diagrams in accordance with various embodiments of the
present invention.

Description of Embodiments

In the following detailed description, reference is made to the accompanying
25 drawings that show, by way of illustration, specific embodiments in which the invention
may be practiced. These embodiments are described in sufficient detail to enable those
skilled in the art to practice the invention. It is to be understood that the various
embodiments of the invention, although different, are not necessarily mutually exclusive.
For example, a particular feature, structure, or characteristic described herein in
30 connection with one embodiment may be implemented within other embodiments without
departing from the spirit and scope of the invention. In addition, it is to be understood that
the location or arrangement of individual elements within each disclosed embodiment may
be modified without departing from the spirit and scope of the invention. The following

detailed description is, therefore, not to be taken in a limiting sense, and the scope of the present invention is defined only by the appended claims, appropriately interpreted, along with the full range of equivalents to which the claims are entitled. In the drawings, like numerals refer to the same or similar functionality throughout the several views.

5 Figure 1 shows a diagram of an electronic system with a cooling system. Electronic system 100 includes fuel cell 110, fuel delivery pump 126, battery 120, and heat generating device 102. Fuel cell 110 may be any type of fuel cell capable of producing power. For example, fuel cell 110 may be a direct methanol fuel cell, a reformed methanol fuel cell, or the like. Battery 120 may be any type of battery capable 10 of storing an electrical charge. Heat generating device 102 may be any device within electronic system 100 that generates heat. In some embodiments, heat generating device 102 may include an integrated circuit that receives power from the combination of fuel cell 110 and battery 120.

15 Electronic system 100 also includes a cooling system to cool fuel cell 110 and heat generating device 102. The cooling system includes cooling system pump 104, fan 106, and heat exchanger 108. The cooling system also includes a fluid cooling medium that flows in path 112. Path 112 may include flexible tubing, rigid piping, or the like. In some embodiments, path 112 may also include valves and quick-disconnects throughout. Path 20 112 traverses heat generating device 102 and fuel cell 110 to remove heat from those devices, and also traverses heat exchanger 108 to remove heat from electronic system 100.

As shown in Figure 1, path 112 traverses in the order of heat generating device 102, fuel cell 110, heat exchanger 108, and pump 104, but this is not a limitation of the present invention. For example, path 112 may traverse fuel cell 110 prior to heat generating device 102, or after heat exchanger 108. Further, in some embodiments, 25 multiple heat exchangers are included. For example, path 112 may traverse one or more heat exchangers after passing through each heat generating device.

The cooling system recirculates a fluid cooling medium to cool various components of electronic system 100. The fluid cooling medium may be any type of fluid capable of carrying heat. In some embodiments, the fluid cooling medium may be water, 30 and in other embodiments, the fluid cooling medium may be a liquid metal such as a gallium-indium based low melting point alloy. In some embodiments, the fluid cooling medium experiences a phase change while traversing path 112, and in other embodiments, the fluid cooling medium remains in the same state. For example, in some embodiments,

a fluid cooling medium may transition from a liquid to a vapor and back while traversing path 112.

In some embodiments, heat generating device 102 includes a heat sink through which the fluid cooling medium can pass. In other embodiments, heat generating device 5 102 includes packaging having integrated cooling passages through which the fluid cooling medium can pass. Fuel cell 110 may also include a heat sink through which the fluid cooling medium can pass. In other embodiments, fuel cell 110 includes electrodes with integrated cooling passages through which the fluid cooling medium can pass. Example embodiments of fuel cells with integrated cooling passages are described with 10 reference to later figures.

In some embodiments, electronic system 100 includes temperature sensors to sense a temperature of one or more components or subsystems of the system. For example, as shown in Figure 1, electronic system 100 includes temperature sensor 130 to sense a temperature of fuel cell 110, and also includes temperature sensor 132 to sense a 15 temperature of heat generating device 102. Any number of temperature sensors may be included in electronic system 100. Although only two temperature sensors are shown in Figure 1, this is not a limitation of the present invention. Any type of temperature sensing device may be utilized. For example, in some embodiments, thermocouples or thermal diodes are used for temperature sensors. In some embodiments, temperature sensors may 20 be used in conjunction with one or more control systems. Example embodiments of control systems are described below with reference to later figures.

Fuel cell 110, battery 120, and heat generating device 102 are coupled by conductor 122. In some embodiments, fuel cell 110 provides power to heat generating device 102 and to battery 120 using conductor 122. In this manner, fuel cell 110 may 25 charge battery 120 and provide power to subsystems of electronic system 100.

In operation, an instantaneous power requirement of a subsystem or component may exceed the steady-state output of fuel cell 110. This may occur when a component requests more than the maximum output of fuel cell 110 or when a component experiences a transient power requirement above the current operating level of fuel cell 110. Battery 30 120 may provide power to subsystems during periods when power demands on fuel cell 110 are high. For example, battery 120 may provide power to heat generating device 102 using conductor 122.

Fuel cell 110 may produce power (and heat) at various rates. For example, if fuel is delivered to fuel cell 110 at a low rate, the power and heat produced by fuel cell 110 may be relatively low. In contrast, if fuel is delivered to fuel cell 110 at a high rate, the power and heat produced by fuel cell 110 may be relatively high. The fuel delivery rate 5 may be modified using various settings for fuel delivery pump 126.

In some embodiments, cooling system pump 104 includes a variable control. By varying the rate at which pump 104 pumps the fluid cooling medium, the amount of cooling provided by the cooling system may be varied. Some embodiments of the present invention include intelligent control of the fuel delivery pump and the cooling system 10 pump to allow for efficient power delivery and heat removal. Example embodiments are described with reference to later figures.

Electronic system 100 is shown with major components in a block diagram. Electronic system 100 may include many more subsystems, components, and the like, without departing from the scope of the present invention. Further, electronic system 100 15 may be any platform that may benefit from a fuel cell and integrated cooling system. For example, in some embodiments, electronic system 100 may be a notebook computer or a laptop computer, and may include many additional computer components.

In some embodiments, system 100 includes antenna 103. Antenna 103 may be used to transmit and receive signals. For example, in some embodiments, heat generating 20 device 102 may include wireless communications capabilities, and antenna 103 may be coupled to integrated circuits, components, or subsystems within heat generating device 102. Any of the disclosed embodiments may have wireless communications capabilities, and also may include one or more antennae.

Figure 2 shows example heat generating devices. Heat generating devices 200 25 includes two integrated circuits: graphics chip 210, and processor 220. In some embodiments, heat generating devices 200 are in a system, such as heat generating device 102 in electronic system 100. Graphics chip 210 and processor 220 are shown coupled to fluid cooling path 112. In some embodiments, graphics chip 210 and processor 220 include heat sinks with fluid passages through which the fluid cooling medium can pass. 30 In other embodiments, graphics chip 210 and processor 220 include packaging with integral fluid passages through which the fluid cooling medium can pass.

Although Figure 2 shows two devices, this is not a limitation of the present invention. For example, heat generating devices 200 may include memory components,

memory controllers or peripheral controllers, or any other component or subsystem that generates heat. Fluid cooling path 112 may traverse the components or subsystems in any order without departing from the scope of the present invention. Further, in some embodiments, heat generating devices 200 may only include one device.

5 In some embodiments, heat generating devices 200 includes temperature sensors to sense a temperature of one or more components or subsystems. For example, as shown in Figure 2, graphics chip 210 includes temperature sensor 212, and processor 220 includes temperature sensor 222. Any number of temperature sensors may be included without departing from the scope of the present invention. In some embodiments, temperature
10 sensors may be used in conjunction with one or more control systems. Example embodiments of control systems are described below with reference to later figures.

Figure 3 shows an exploded view of a fuel cell. Fuel cell 300 includes electrodes 302 and 304, and stack 310. Fuel cell 300 may be any type of fuel cell that includes electrodes. For example, fuel cell 300 may be a direct methanol fuel cell, a reformed
15 methanol fuel cell, or the like. Fuel cell 300 may be included in an electronic system with integrated platform and fuel cell cooling. For example, fuel cell 300 may be used as fuel cell 110 (Figure 1). Stack 310 is shown thin for ease of illustration. In some embodiments, stack 310 includes membranes, electrolytes, and the like. Further, in some embodiments, stack 310 includes more electrodes to allow multiple cells to be electrically
20 coupled in series.

As shown in Figure 3, electrode 302 includes fluid passageways 320, and electrode 304 includes fluid passageways 340. Fluid passageways 320 and 340 may be utilized to carry a fluid cooling medium. In some embodiments, the passageways 320 and 340 are interconnected. For example, in some embodiments, a fluid path exists within electrode
25 302, between electrodes 302 and 304, and within electrode 304. In these embodiments, a fluid inlet may be present on electrode 302, and a fluid outlet may be present on electrode 304.

In some embodiments, a fluid passageway exists in a heatsink that is separate from electrode 302. In these embodiments, the heatsink may be part of a fluid cooling path, and
30 the heatsink may be thermally affixed to one or both of electrodes 302 or 304.

In some embodiments, fuel cell 300 includes one or more temperature sensors. As shown in Figure 3, fuel cell 300 includes temperature sensor 322 coupled to electrode 302. A temperature sensor may be coupled to an electrode with a fluid passageway or to an

electrode without a fluid passageway. A temperature sensor may also be coupled to a part of fuel cell 300 other than an electrode.

Figure 4 shows a diagram of a control system. Control system 400 includes power management control block 410, fuel delivery pump 126, cooling pump 104, fan 106, fuel cell 110, and processor 450. In operation, power management control block 410 receives a fuel cell temperature (TEMPF) from a temperature sensor in fuel cell 110, and also receives a processor temperature (TEMPP) from a temperature sensor in processor 450. In some embodiments, the processor temperature corresponds to the junction temperature of transistors within processor 450. Power management control block 410 may also receive 10 temperature information from other components. For example, power management control block 410 may receive temperature information describing the temperature of memory devices or controllers, graphics devices or controllers, or the like.

In response to temperature information, power management control block 410 may vary the rate of cooling pump 104, fan 106, and/or fuel delivery pump 126. Power 15 management control block 410 may also control the frequency or performance of processor 450. For example, if one or more temperatures are high, then power management control block 410 may increase the flow rate of cooling pump 104, increase the speed of fan 106, reduce the voltage of processor 450, reduce the operating frequency of processor 450, reduce the rate of fuel delivery pump 126, or any combination. If one or 20 more temperatures are low, power management control block 410 may decrease the flow rate of cooling pump 104, decrease the speed of fan 106, increase the voltage of processor 450, increase the operating frequency of processor 450, increase the flow rate of fuel delivery pump 126, or any combination.

Power management control block 410 may be implemented in any suitable manner. For example, in some embodiments, power management control block 410 may 25 be implemented in hardware as a state machine or a dedicated sequential controller. Also for example, in other embodiments, power management control block 410 may be implemented in software as part of an operating system or power management software application. Power management control block 410 may also be implemented as a combination of hardware and software. The manner in which power management control 30 block 410 is implemented is not a limitation of the present invention.

Figure 5 shows an electronic system having a processor and memory. Figure 5 shows system 500 including processor 510, and memory 520. Processor 510 may be a

processor that can run an operating system that implements a control block such as that shown in Figure 4. For example, processor 510 may receive temperature information and power information, and modify power output levels or power consumption levels, or modify cooling system performance. Also for example, processor 510 may perform any 5 of the method embodiments of the present invention. Processor 510 represents any type of processor, including but not limited to, a microprocessor, a microcontroller, a digital signal processor, a personal computer, a workstation, or the like.

Memory 520 represents an article that includes a machine readable medium. For example, memory 520 represents any one or more of the following: a hard disk, a floppy 10 disk, random access memory (RAM), dynamic random access memory (DRAM), static random access memory (SRAM), read only memory (ROM), flash memory, CDROM, or any other type of article that includes a medium readable by processor 520. Memory 520 can store instructions for performing the execution of the various method embodiments of the present invention.

15 Figure 6 shows a flowchart in accordance with various embodiments of the present invention. In some embodiments, method 600 may be used to modify power output or power consumption of various devices. In other embodiments, method 600 may be used to modify heat generation or cooling of various devices. In some embodiments, method 600, or portions thereof, is performed by a an electronic system with integrated platform 20 and fuel cell cooling, or a control system, embodiments of which are shown in the various figures. Method 600 is not limited by the particular type of apparatus, software element, or person performing the method. The various actions in method 600 may be performed in the order presented, or may be performed in a different order. Further, in some embodiments, some actions listed in Figure 6 are omitted from method 600.

25 Method 600 is shown beginning at block 610 in which a temperature is sensed within a cooling system adapted to cool a fuel cell and at least one other device. In some embodiments, the at least one other device may be powered by the fuel cell, or partially powered by the fuel cell. The sensed temperature may be a temperature of the fuel cell or may be a temperature of the at least one other device. For example, the temperature of a 30 processor such as processor 450 (Figure 4) may be sensed, or the temperature of a fuel cell such as fuel cell 110 (Figure 1) may be sensed.

At 620, a power consumption is measured. In some embodiments, the power consumption may be a power consumption of a processor such as processor 450 (Figure 4)

or processor 510 (Figure 5). Power consumption may be measured by measuring an actual current flow, or may be measured to checking a state of a device. For example, a device such as a processor may have multiple power states that can be checked by reading a register value. In some embodiments of the present invention, power consumption is not measured, and power state information is not available. In these embodiments, block 620 is omitted from method 600.

At 630, a fluid flow of the cooling system is modified. The fluid flow may be modified by modifying a flow rate of a cooling system pump such as pump 104 (Figures 1, 4). In addition to modifying a fluid flow, a fan speed may also be modified. In some 10 embodiments, the fluid flow or fan speed may be modified to increase the cooling effect of the cooling system in response to elevated temperatures. In other embodiments, the fluid flow or fan speed may be modified to decrease the cooling effect of the cooling system in response to reduced temperatures.

At 640, a power output of the fuel cell may be modified. The power output of the 15 fuel cell may be modified by modifying a flow rate of a fuel delivery pump such as fuel delivery pump 126 (Figures 1, 4). In some embodiments, the power output of the fuel cell may be increased due to increased power requirements. In other embodiments, the power output of a fuel cell may be increased to charge a battery when the cooling system has excess cooling capacity. For example, a control system such as control system 400 20 (Figure 4) may sense lower temperatures that indicate the cooling system has extra cooling capacity. The extra cooling capacity may be utilized by increasing the flow of a fuel delivery pump to increase the power generation of the fuel cell to charge a battery.

At 650, the power consumption of the at least one device may be modified. In some 25 embodiments, actions represented by block 650 may correspond to throttling the performance of a microprocessor to reduce the generated heat. For example, a control system may reduce the power consumption of a processor when a temperature of the processor is elevated. Likewise, in some embodiments, a control system may increase the power consumption of a processor to increase performance when the temperature of the processor is low.

Method 600 represents the intelligent control of power generation, power 30 consumption, and cooling in an electronic system with integrated platform and fuel cell cooling. When excess cooling capacity exists in the cooling system, the excess cooling

capacity may be used to produce more power with a fuel cell to charge a battery or to power the system to a higher performance level.

Figures 7-9 show electronic systems in accordance with various embodiments of the present invention. Each of Figures 7-9 may include systems such as electronic system 100 (Figure 1), or control system 400 (Figure 4). Further, each of the electronic systems shown in Figures 7-9 may include wireless communications capabilities, and further may include one or more antennae.

Figure 7 shows a computer having an external fuel cell. External fuel cell 710 may be a fuel cell such as fuel cell 110 (Figure 1) or fuel cell 300 (Figure 3). In some 10 embodiments, external fuel cell 710 is coupled to computer 700 by multiple conductors and fluid lines. For example, conductors may be provided to receive power from fuel cell 710 and also to receive temperature information from a temperature sensor within fuel cell 710. Conductors may also be provided to allow computer 700 to modify the flow rate of a fuel delivery pump in fuel cell 700. In some embodiments, fluid lines with quick-disconnects may be included to between fuel cell 710 and computer 700 to allow the easy 15 removal of fuel cell 710.

Figure 8 shows a computer with a fuel cell in a “swappable bay.” As used herein, the term “swappable bay” refers to a bay substantially within the form factor of computer 800. The swappable bay may or may not accept devices other than fuel cell 810. For 20 example, the swappable bay may accept devices such as a DVD drive, a battery, or the like.

Fuel cell 810 may be a fuel cell such as fuel cell 110 (Figure 1) or fuel cell 300 (Figure 3). In some embodiments, the swappable bay includes multiple electrical 25 conductors and fluid lines. For example, conductors may be provided to receive power from fuel cell 810 and also to receive temperature information from a temperature sensor within fuel cell 810. Conductors may also be provided to allow computer 800 to modify the flow rate of a fuel delivery pump in fuel cell 800. In some embodiments, fluid lines with quick-disconnects may be included to between fuel cell 810 and computer 800 to allow the easy removal of fuel cell 810.

30 Figure 9 shows a computer with a semi-permanently affixed fuel cell. As used herein, the term “semi-permanently affixed” refers to a device that is not designed to be readily removed by a consumer. Although fuel cell 910 is semi-permanently affixed within computer 900, a fuel cartridge within, or coupled to, fuel cell 910 may be readily

removed by a consumer. For example, in embodiments that include a fuel cell powered by methanol, a disposable or refillable methanol canister may be readily removable. Fuel cell 910 may be a fuel cell such as fuel cell 110 (Figure 1) or fuel cell 300 (Figure 3).

Although the present invention has been described in conjunction with certain
5 embodiments, it is to be understood that modifications and variations may be resorted to without departing from the spirit and scope of the invention as those skilled in the art readily understand. Such modifications and variations are considered to be within the scope of the invention and the appended claims.

What is claimed is:

1. An apparatus comprising:
 - a fuel cell;
 - 5 an integrated circuit; and
 - a cooling system to cool the fuel cell and the integrated circuit;
 - wherein the cooling system includes a fluid medium to remove heat from the fuel cell and the integrated circuit.
2. The apparatus of claim 1 wherein the fuel cell includes at least one electrode
10 through which the fluid medium passes.
3. The apparatus of claim 1 further comprising a pump to pump the fluid medium.
4. The apparatus of claim 1 further comprising at least one temperature sensor.
5. The apparatus of claim 4 wherein the temperature sensor is configured to sense a
temperature of the fuel cell.
- 15 6. The apparatus of claim 4 wherein the temperature sensor is configured to sense a
temperature of the integrated circuit.
7. The apparatus of claim 4 further comprising a control system adapted to modify a
fluid flow in response to a temperature sensed by the temperature sensor.
- 20 8. The apparatus of claim 4 further comprising a control system adapted to modify a
power output level of the fuel cell in response to a temperature sensed by the temperature
sensor.
9. The apparatus of claim 1 wherein the integrated circuit comprises a processor.
10. The apparatus of claim 1 further comprising a plurality of heat generating devices
coupled to the cooling system.

11. The apparatus of claim 1 wherein the fluid medium comprises a liquid metal.

12. The apparatus of claim 1 wherein the cooling system is adapted to have the fluid medium transition through a phase change.

13. An apparatus comprising:

5 a fuel cell having an electrode with passageways through which a fluid cooling medium can pass; and

a fluid path adapted to be coupled to the passageways and to a heat generating device other than the fuel cell.

14. The apparatus of claim 13 further comprising a pump coupled to the electrode, the
10 pump configured to pump the fluid cooling medium through the passageways.

15. The apparatus of claim 13 further comprising an integrated circuit coupled to the fluid path.

16. The apparatus of claim 15 wherein the integrated circuit comprises a graphics circuit.

15 17. The apparatus of claim 15 wherein the integrated circuit comprises a processor.

18. The apparatus of claim 13 further comprising a temperature sensor.

19. The apparatus of claim 18 further comprising a control system to increase the fuel cell output when a temperature sensed by the temperature sensor drops.

20. A method comprising:

20 sensing a temperature within a cooling system adapted to cool a fuel cell and a device at least partially powered by the fuel cell; and
modifying a fluid flow of the cooling system.

21. The method of claim 20 wherein sensing a temperature comprises sensing a temperature of the fuel cell.

22. The method of claim 20 wherein sensing a temperature comprises sensing a temperature of the at least one other device.

5 23. A method comprising:

sensing a temperature within a cooling system adapted to cool a fuel cell and at least one other device; and

modifying a power output of the fuel cell.

10 24. The method of claim 23 wherein sensing a temperature comprises sensing a temperature of the fuel cell.

25. The method of claim 23 wherein sensing a temperature comprises sensing a temperature of the at least one other device.

26. The method of claim 25 wherein modifying a power output comprises increase the power output when the temperature drops.

15 27. An apparatus including a medium adapted to hold machine-accessible instructions that when accessed result in a machine performing:

sensing a temperature within a cooling system adapted to cool a fuel cell and at least one other device; and

modifying a power output of the fuel cell.

20 28. The apparatus of claim 27 wherein sensing a temperature comprises sensing a temperature of the at least one other device.

29. The apparatus of claim 28 wherein modifying a power output comprises increase the power output when the temperature drops.

30. An electronic system comprising:

a fuel cell;
an integrated circuit;
a cooling system to cool the fuel cell and the integrated circuit, wherein the cooling system includes a fluid medium to remove heat from the fuel cell and the integrated
5 circuit; and
an antenna coupled to the integrated circuit.

31. The electronic system of claim 30 wherein the electronic system comprises a computer.
32. The electronic system of claim 31 wherein the fuel cell is external to the computer.
- 10 33. The electronic system of claim 31 wherein the fuel cell is in a swappable bay of the computer.
34. The electronic system of claim 31 wherein the fuel cell is semi-permanently affixed within the computer.

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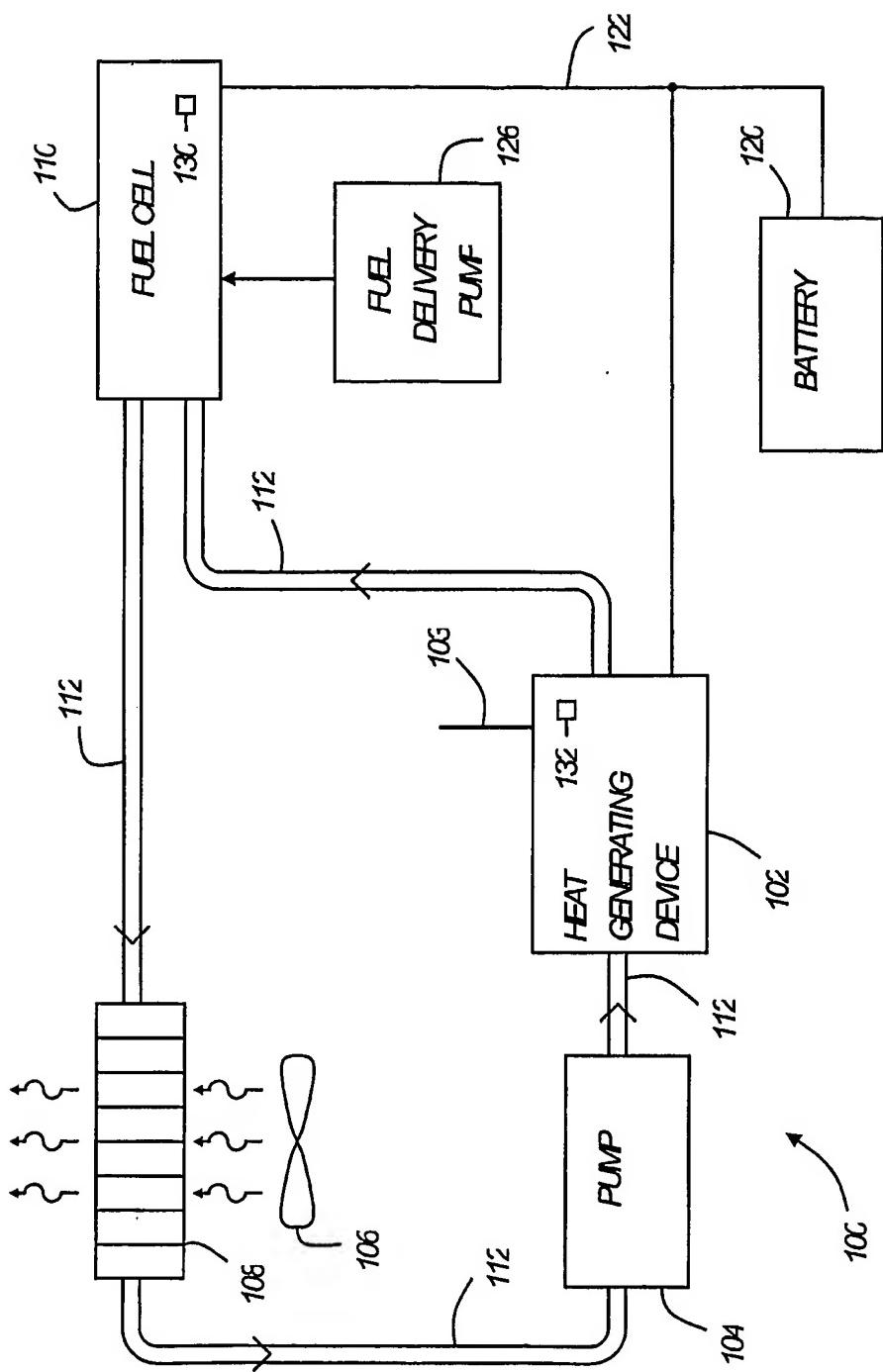


FIG. 1

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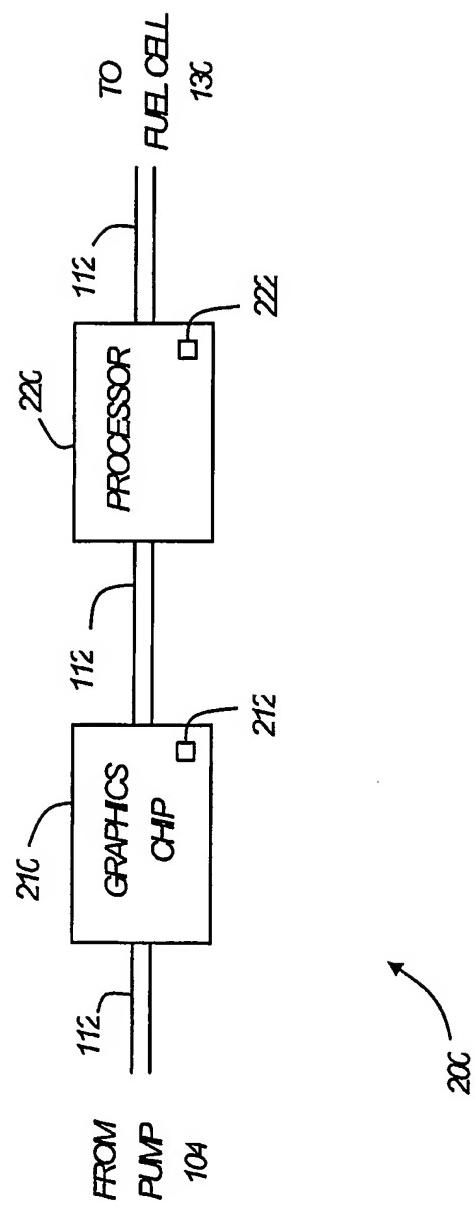


FIG. 2

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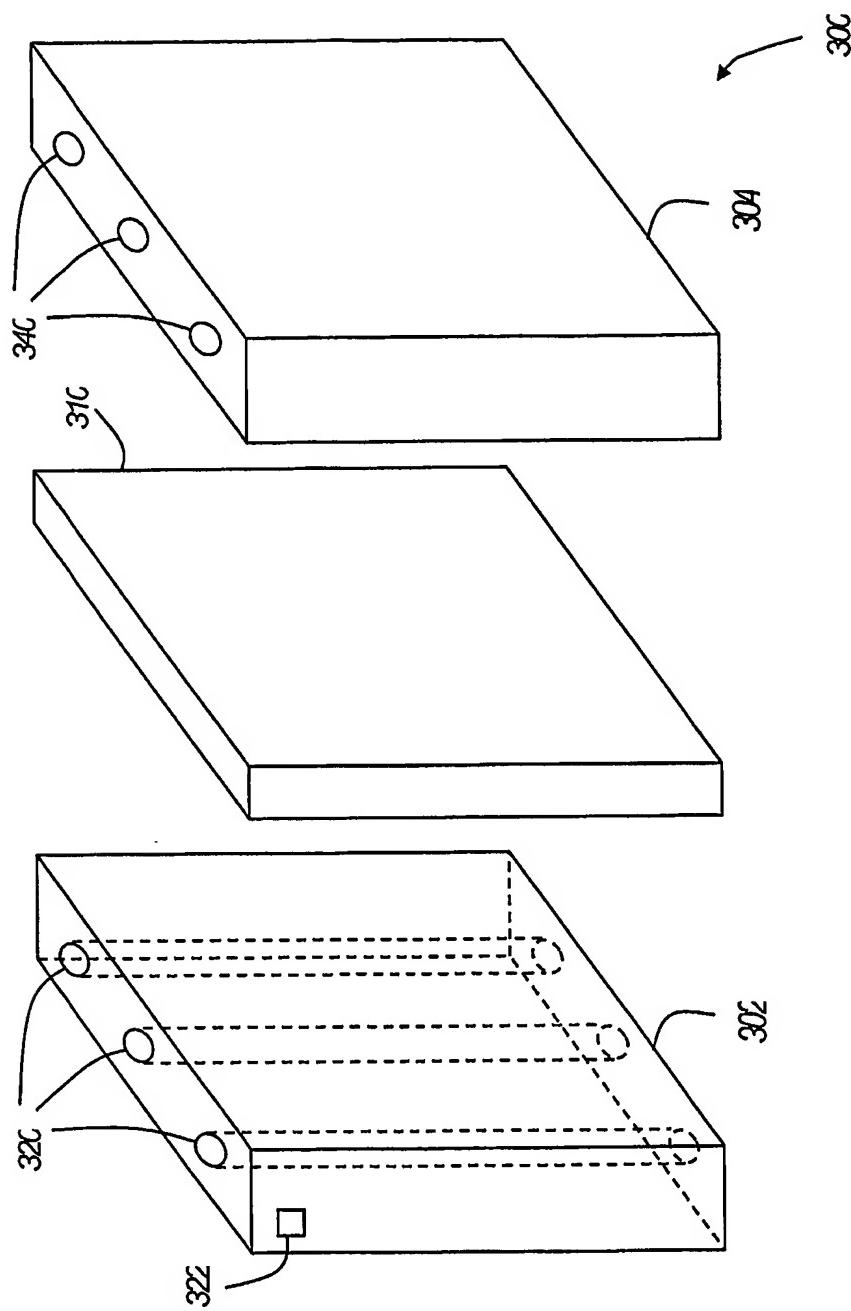


FIG. 3

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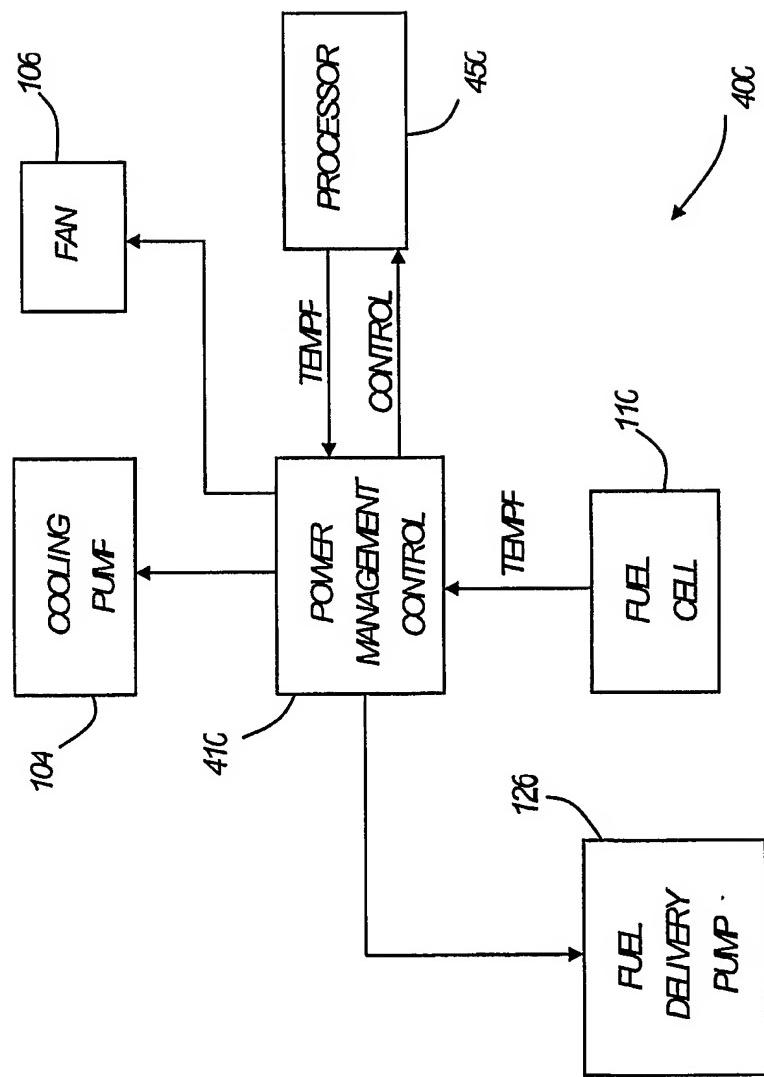


FIG. 4

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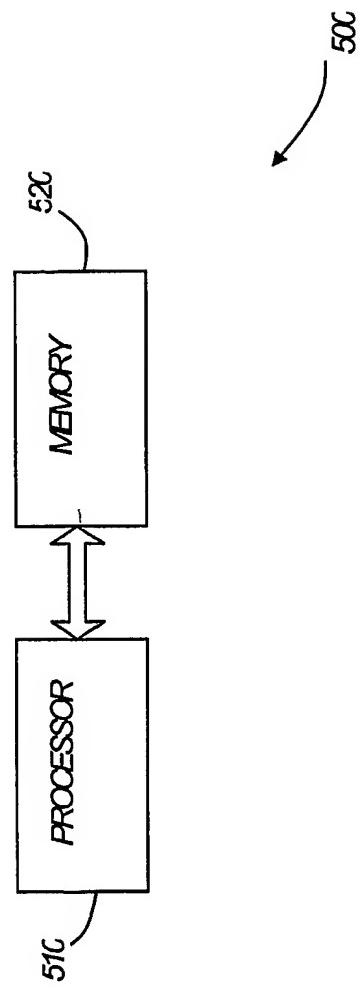


FIG. 5

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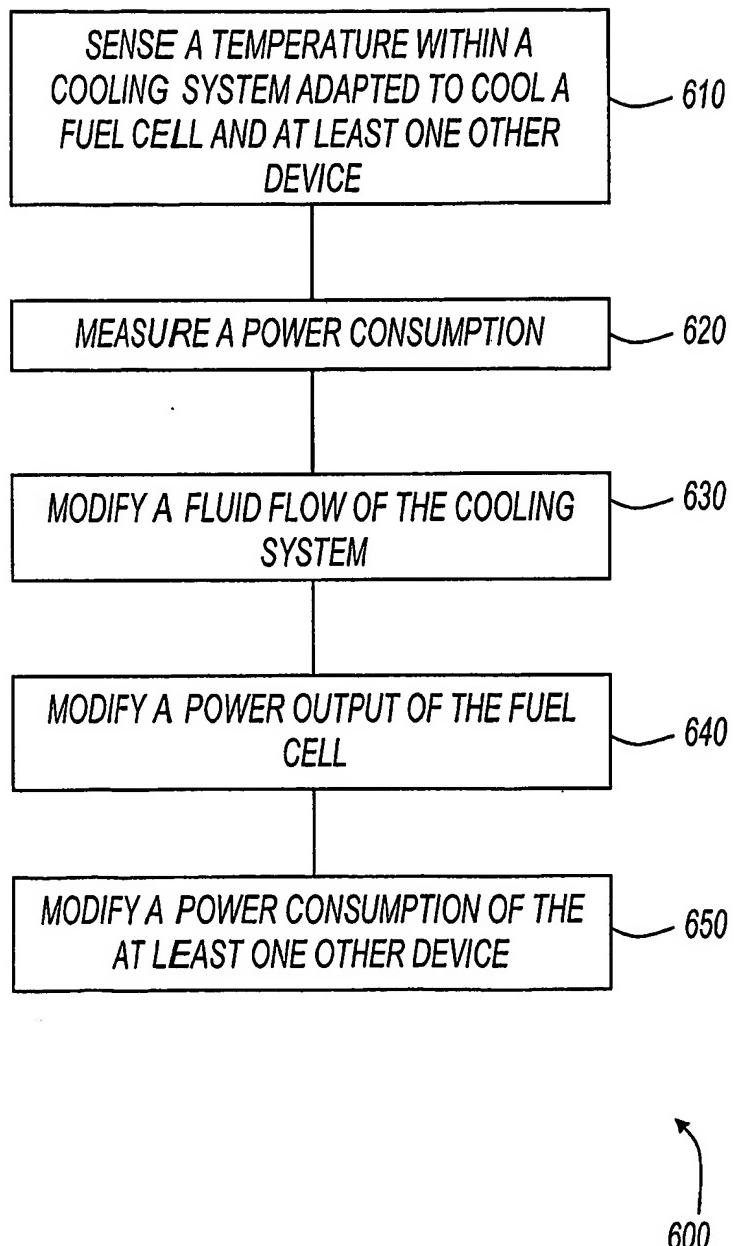


FIG. 6

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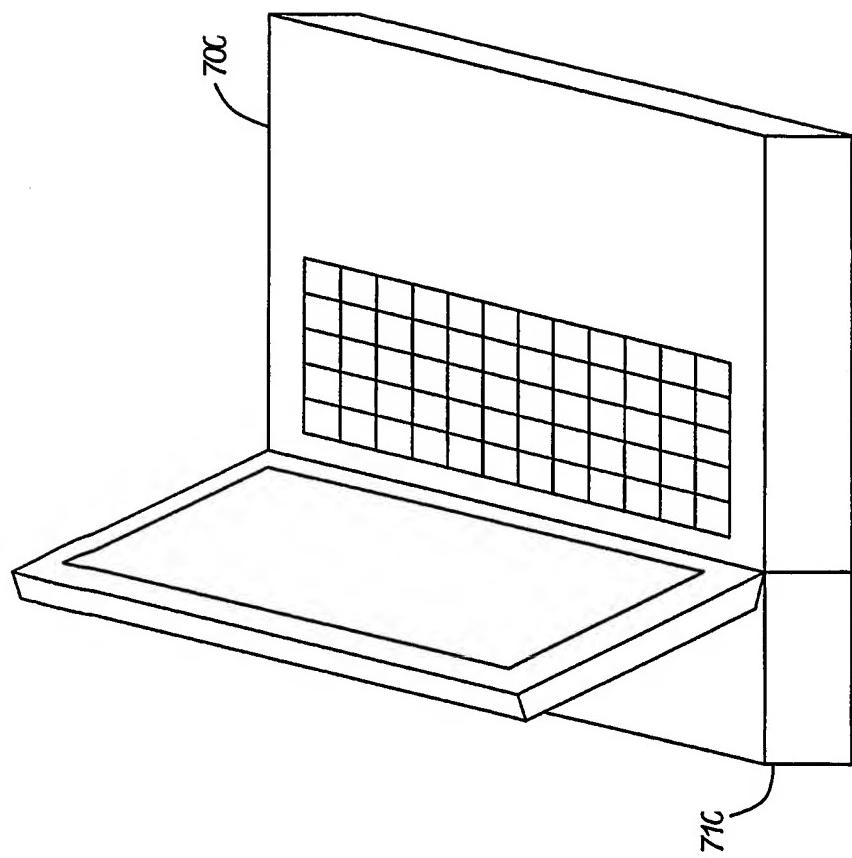


FIG. 7

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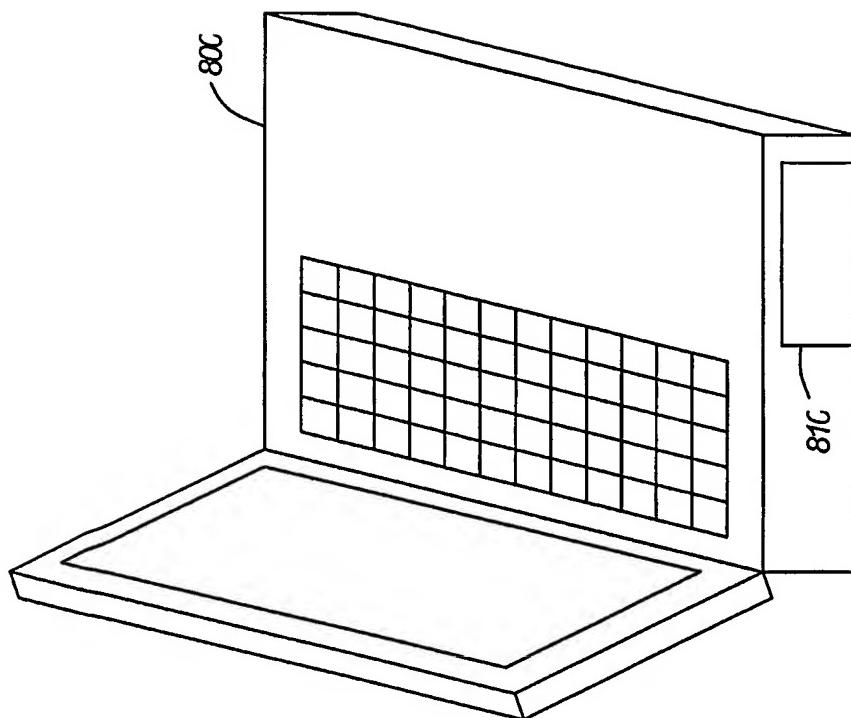


FIG. 8

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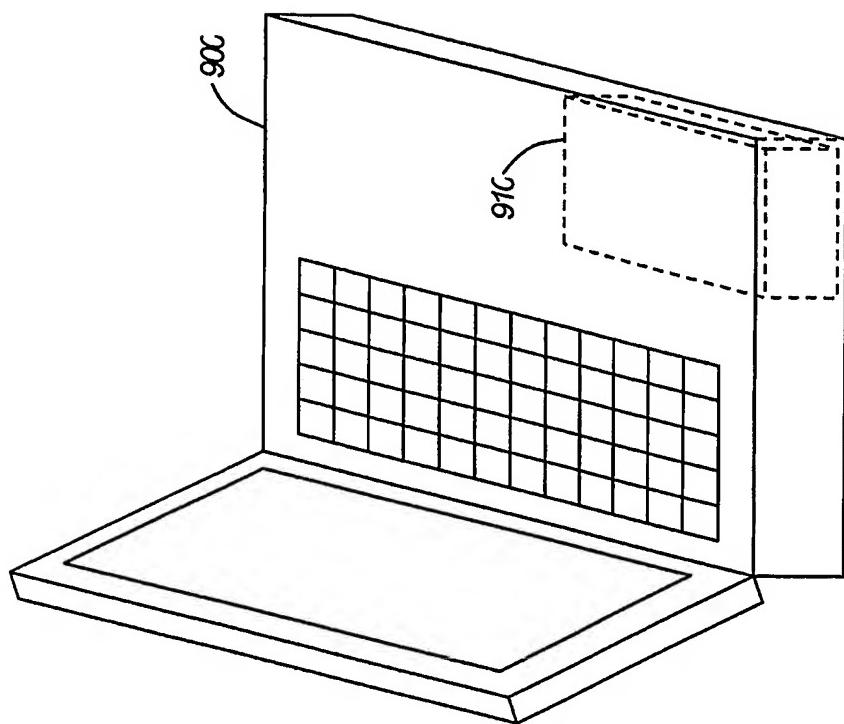


FIG. 9